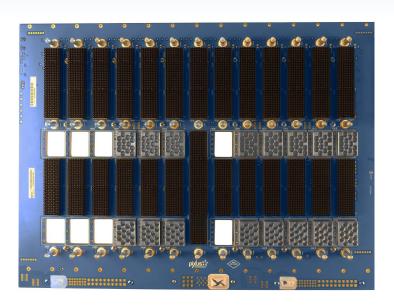


VPX606, 607 Backplanes



VPX60X KEY FEATURES

- Compliant to latest VITA 65, VITA 66.x, and VITA 67.x specifications
- Various OpenVPX & SOSA aligned slot profiles—contact Pixus for details
- Various slot sizes and configurations available
- 6U backplane design
- 1.0" slot pitch standard, customized sizes available
- Data rate options up to 100GbB using RT-3 high speed connectors
- Selectable rear IO options
- Fast turnaround, superior performance
- Customization available
- Conformal coating optional





OpenVPX is a process that defines system level VPX interoperability for multi-vendor, multi-module, integrated systems environment. The OpenVPX process defines clear interoperability points necessary for integration between Module to Module, Module to Backplane and Chassis. VITA 67 adds RF capability to the backplane with multi-position blind mate connectors.

Pixus has an experienced team of OpenVPX experts and can help you find or create the OpenVPX backplane profile for your application. We offer various data signal speed options and have optional testing services. Pixus is IS09001:2015 and ITAR registered.

The backplanes are typically 1.0" pitch, but 0.8" pitch is available in some configurations. Contact Pixus for details.

Pixus Technologies can modify this product to meet special customer requirements without NRE (minimum order placement is required).





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Specifications

Architecture		
Physical	Dimensions	Height: 6U
		Width: Depending on slot #
		Pitch: 1.0" standard (0.8" optional)
	Connectors	MultiGig RT-2 or RT-3 (for above 40GbE), VITA 67.x coax, VITA 66.x optical
	Layers	18-24 layers typical
Standards		
VITA	Туре	VITA 65, VITA 46 for OpenVPX
	Туре	VITA 66 for Optical, VITA 67 for RF over OpenVPX
Configuration		
Power		3.3V_AUX, 5V, +/- 12V, +/- 12V_AUX
Environmental	Temperature	Operating temperature: up to -40° to +85°C options
		Storage temperature: up to -55° to +90°C options
	PCB	FR406 or equivalent, Nelco4000-13SI, Meg7 or equivalent for higher speeds
		(consult Pixus)
	PCB traces	0.5 oz. copper standard
Conformal coating		Upon request (See page 5 selection "J" for available options)
Other		
MTBF	MIL Handbook 217-F @ TBD Hrs.	
Certifications	Designed to meet FCC, CE and EN/UL/TUV certifications where applicable	
Warranty	Two years	
Trademarks and logos	The Pixus Logo is a registered trademark of Pixus Technologies Inc. other registered trademarks are the property of their respective owners. Specs. subject to change without notice.	



Connectors & Signals

Connector Ratings

Multi-Gig RT-2 (contact factory for RT-3 specs):

Operating Voltage: 50 Volts AC peak or DC Current: 1 Ampere at <30°C (single circuit, free air)

Temperature: -55 to 105°C

Low level contact resistance, circuit: 80 milliohms maximum initial

5 milliohms maximum average increase 10 milliohms maximum individual increase

Low level contact resistance, compliant pin: 1 milliohm maximum initial

1 milliohm maximum change

Insulation resistance: 1000 megohms minimum

Withstanding voltage: 1 minute hold with no breakdown or flashover

Temperature rise vs. current: 30°C maximum temperature at 1 Ampere load, single circuit in free air using thermography

Mechanical Vibration, sinusodial:

Mechanical Vibration: No discontunuities of 1 microsecond or longer duration Mechanical Shock: No discontunuities of 1 microsecond or longer duration

Mating Force: 0.75 N [2.7 ozf] maximum per contact. Average for entire connector. Unmating Force: 0.15 N [.57 ozf] minimum per contact. Average for entire connector.

Compliant pin insertion: 31 N [7 lbf] maximum per pin average

Compliant pin retention: 13.35 N [3 lbf] minimum

Multi-Gig RT-3:

Speed: 25+ Gbps Mating cycles: 500

PCB hole dimensions: 0.37 (ref)

Signal Definitions:

Fat Pipe: A channel that is comprised of four links (4 Tx pairs + 4 Rx pairs) is now being referred to as a fat pipe or by use of the x4 nomenclature. 10Gbps capable 10GBase-KX4, 10GBase-BX4, 10GBase-T, PCIe-x4, sRIO-x4, Infiniband-x4

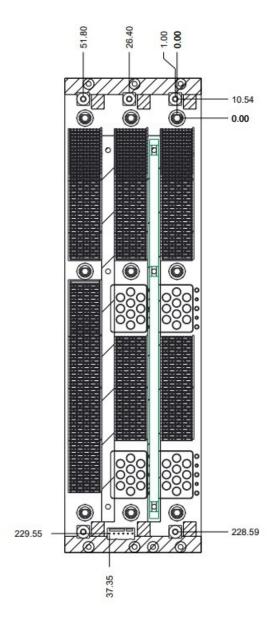
Thin Pipe: A channel that is comprised of two links (2 Tx pairs + 2 Rx pairs) is now being referred to as a thin pipe or by use of the x2 nomenclature. 5Gbps capable 10/100/1000Base-T, 1000Base-BX, PCIe-x2, sRIO-x2, Infiniband-x2

Ultra-thin Pipe: A channel that is comprised of one link (1 Tx pair + 1 Rx pair) is now being referred to as an ultra-thin pipe or by use of the x1 nomenclature. 10GBase-KR, IGBase-KX, PCIe-x1, sRIO-x1, Infiniband-x1a



6U Drawing Example —2 VITA 67.3c Slots and 1 VPX Slot

SOSA Aligned Profile Example



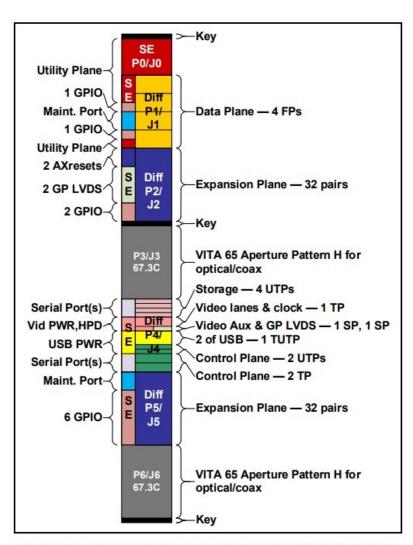


Figure 10.6.4-1 SLT6-PAY-4F2Q1H4U1T1S1S1TU2U2T1H-10.6.4-n

Pixus has multiple backplane options that support the various SOSA slot profiles. SOSA aligned systems utilize just the 12V (VS1) rail along with some 3.3 AUX. The IPMB is routed across the backplane to support the use of a SOSA aligned chassis manager and VITA 46.11 compliant versions. Visit https://pixustechnologies.com/products/enclosure-system-solutions/vpx-vme64x-chassis-2/openvpx-3u-6u-sosa/ to see Pixus' offering of SlotSaverTM mezzanine-based and pluggable SOSA aligned/VITA 46.11 chassis manager options.

An examples of the wide variety of options are shown above. Several of the Pixus power and ground and routed backplanes have cutouts for Aperture H (VITA 67.3c) or other RF/Fiber sizes (Aperture J—VITA 67.3d, etc)



Ordering Options VPX606=6U OpenVPX Backplane, VITA 66.1 or 66.4 VPX607=6U OpenVPX Backplane, VITA 67.x or Hybrid

